## Product / Package Information

<table>
<thead>
<tr>
<th>Package</th>
<th>LFCSP - Sawn</th>
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<tbody>
<tr>
<td>Body Size (mm)</td>
<td>4 x 4 x 0.75 (2.6 EP)</td>
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<tr>
<td>Lead Count</td>
<td>16</td>
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<tr>
<td>Terminal Finish</td>
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<tr>
<td>MS Number</td>
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## Environmental Information

<table>
<thead>
<tr>
<th>RoHS Compliant</th>
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<tbody>
<tr>
<td>High Temperature Compliant</td>
<td>Yes</td>
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<tr>
<td>Halogen Free Compliant</td>
<td>Yes</td>
</tr>
<tr>
<td>REACH SVHC Compliant</td>
<td>Yes</td>
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## Materials Declaration

### Molding Compound

<table>
<thead>
<tr>
<th>Description</th>
<th>Substance</th>
<th>CAS#</th>
<th>Weight (g)</th>
<th>Homogeneous Material Level</th>
<th>Component Level</th>
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</thead>
<tbody>
<tr>
<td>Other inorganic materials</td>
<td>Silicon</td>
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### Leadframe

<table>
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<tr>
<th>Description</th>
<th>Substance</th>
<th>CAS#</th>
<th>Weight (g)</th>
<th>Homogeneous Material Level</th>
<th>Component Level</th>
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</thead>
<tbody>
<tr>
<td>Copper &amp; its alloys</td>
<td>Copper</td>
<td>7440-55-6</td>
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### Internal Leadframe Plating

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<th>Component Level</th>
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<tr>
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<tr>
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### Chip

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### Die Attach

<table>
<thead>
<tr>
<th>Description</th>
<th>Substance</th>
<th>CAS#</th>
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### Package Totals

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<th>PPM</th>
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ADI Proprietary
**Product / Package Information**
- **Package**: LFCSP - Sawn
- **Body Size (mm)**: 4 X 4 X 0.75 (2.6 EP)
- **Lead Count**: 16
- **Terminal Finish**: NiPdAu
- **MS Number**: MS012146A

**Environmental Information**
- **RoHS Compliant**: Yes
- **High Temperature Compliant**: Yes
- **Halogen Free Compliant**: Yes
- **REACH SVHC Compliant**: Yes

---

**Materials Declaration**

**Molding Compound**

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**Leadframe**

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**Die Attach**

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<tr>
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**Package Totals**

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